

## CHINA DEVELOPMENT BANK BENCHMARK BOND ISSUANCE PROGRAMME TENDER ANNOUNCEMENT

## 15 May 2023

Issue Number 230206 Tender Type New Issue Tender Date 16 May 2023 **Tender Time** 9:30 am to 10:30 am Renminbi 12 Billion Offering Amount Interest Type Fixed Coupon Rate Determined at Auction **Interest Payment Frequency** Annually **Interest Payment Date** 17 May One Year Original Tenor 17 May 2024 Maturity Date Issue and Settlement Date 17 May 2023 Dated Date(Value Date) 17 May 2023 19 May 2023 Listing Date Clearing House China Central Depository & Clearing Co.,Ltd China's Inter-bank Bond Market(CIBM) Market Rating Exempted for issuance in CIBM

For offshore issuance, China's Quasi-sovereign ratings, i.e. Moody's: A1(Stable), S&P: A+(Stable)

## \*Disclaimer

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CDB's bond yield curve available at http://www.cdb.com.cn.